- Short-Circuit Protection
- Offset-Voltage Null Capability
- Large Common-Mode and Differential Voltage Ranges
- No Frequency Compensation Required
- Low Power Consumption
- No Latch-Up
- Designed to Be Interchangeable With Fairchild μΑ741

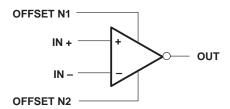
description

The µA741 is a general-purpose operational amplifier featuring offset-voltage null capability.

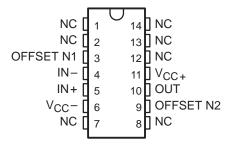
The high common-mode input voltage range and the absence of latch-up make the amplifier ideal for voltage-follower applications. The device is short-circuit protected and the internal frequency compensation ensures stability without external components. A low value potentiometer may be connected between the offset null inputs to null out the offset voltage as shown in Figure 2.

The μ A741C is characterized for operation from 0°C to 70°C. The μ A741I is characterized for operation from -40°C to 85°C.The μ A741M is characterized for operation over the full military temperature range of -55°C to 125°C.

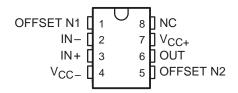
symbol



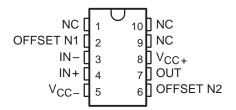
μΑ741M . . . J PACKAGE (TOP VIEW)



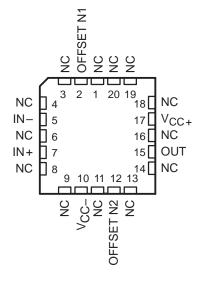
 μ A741M . . . JG PACKAGE μ A741C, μ A7411 . . . D, P, OR PW PACKAGE (TOP VIEW)



 $\begin{array}{c} \mu \text{A741M} \dots \text{U PACKAGE} \\ \text{(TOP VIEW)} \end{array}$



 $\begin{array}{c} \mu \text{A741M} \dots \text{FK PACKAGE} \\ \text{(TOP VIEW)} \end{array}$



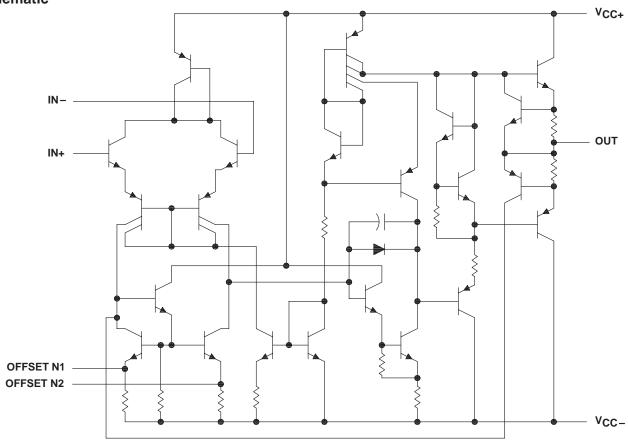
NC - No internal connection

AVAILABLE OPTIONS

			PACKAGED DEVICES								
TA	SMALL OUTLINE (D)	CHIP CARRIER (FK)	CERAMIC DIP (J)	CERAMIC DIP (JG)	PLASTIC DIP (P)	TSSOP (PW)	I PACK				
0°C to 70°C	uA741CD				uA741CP	uA741CPW		uA741Y			
-40°C to 85°C	uA741ID				uA741IP						
−55°C to 125°C		uA741MFK	uA741MJ	uA741MJG			uA741MU				

The D package is available taped and reeled. Add the suffix R (e.g., uA741CDR).

schematic

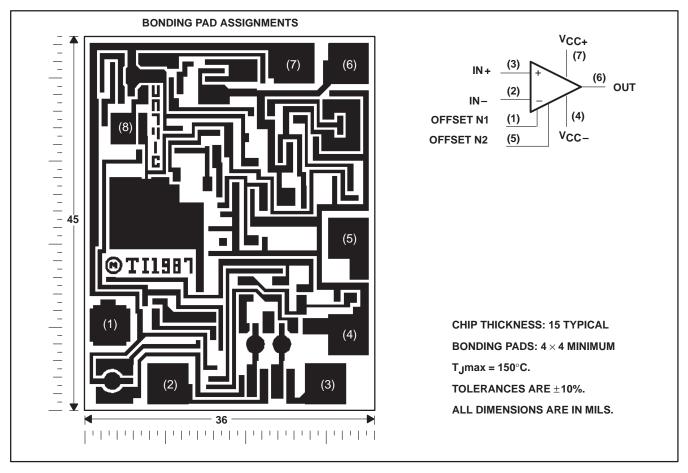


Component Count					
Transistors	22				
Resistors	11				
Diode	1				
Capacitor	1				



μΑ741Y chip information

This chip, when properly assembled, displays characteristics similar to the μ A741C. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. Chips may be mounted with conductive epoxy or a gold-silicon preform.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

		μ Α741C	μ Α741 Ι	μ Α741Μ	UNIT	
Supply voltage, V _{CC+} (see Note 1)		18	22	22	V	
Supply voltage, V _{CC} (see Note 1)			-22	-22	V	
Differential input voltage, V _{ID} (see Note 2)		±15	±30	±30	V	
Input voltage, V _I any input (see Notes 1 and 3)			±15	±15	V	
Voltage between offset null (either OFFSET N1 or OFFSET N2) and V _{CC} _			±15 ±0.5		V	
Duration of output short circuit (see Note 4)			unlimited	unlimited		
Continuous total power dissipation		See Dissipation Rating Table				
Operating free-air temperature range, TA		0 to 70	-40 to 85	-55 to 125	°C	
Storage temperature range		-65 to 150	-65 to 150	-65 to 150	°C	
Case temperature for 60 seconds	FK package			260	°C	
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds	J, JG, or U package			300	°C	
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	D, P, or PW package	260	260		°C	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, unless otherwise noted, are with respect to the midpoint between VCC+ and VCC-.
 - 2. Differential voltages are at IN+ with respect to IN-.
 - 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.
 - 4. The output may be shorted to ground or either power supply. For the μA741M only, the unlimited duration of the short circuit applies at (or below) 125°C case temperature or 75°C free-air temperature.

DISSIPATION RATING TABLE

PACKAGE	T _A ≤ 25°C POWER RATING	DERATING FACTOR	DERATE ABOVE T _A	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	T _A = 125°C POWER RATING
D	500 mW	5.8 mW/°C	64°C	464 mW	377 mW	N/A
FK	500 mW	11.0 mW/°C	105°C	500 mW	500 mW	275 mW
J	500 mW	11.0 mW/°C	105°C	500 mW	500 mW	275 mW
JG	500 mW	8.4 mW/°C	90°C	500 mW	500 mW	210 mW
Р	500 mW	N/A	N/A	500 mW	500 mW	N/A
PW	525 mW	4.2 mW/°C	25°C	336 mW	N/A	N/A
U	500 mW	5.4 mW/°C	57°C	432 mW	351 mW	135 mW



electrical characteristics at specified free-air temperature, $V_{\text{CC}\pm}$ = ± 15 V (unless otherwise noted)

PARAMETER		TEST	T. †	μ Α741C			μ Α74	UNIT		
	PARAMETER	CONDITIONS	T _A †	MIN	TYP	MAX	MIN	TYP	MAX	UNII
VIO	Input offset voltage	V _O = 0	25°C		1	6		1	5	mV
۷۱٥	input onset voltage	10-0	Full range			7.5			6	IIIV
ΔV IO(adj)	Offset voltage adjust range	VO = 0	25°C		±15			±15		mV
li o	Input offset current	V _O = 0	25°C		20	200		20	200	nA
lio	input onset current	10-0	Full range			300			500	ША
I _{IB}	Input bias current	V _O = 0	25°C		80	500		80	500	nA
чВ	input bias current	10-0	Full range			800			1500	ША
VICR	Common-mode input		25°C	±12	±13		±12	±13		V
VICR	voltage range		Full range	±12			±12			V
		$R_L = 10 \text{ k}\Omega$	25°C	±12	±14		±12	±14		_
Vом	Maximum peak output	$R_L \ge 10 \text{ k}\Omega$	Full range	±12			±12			V
VOM	voltage swing	$R_L = 2 k\Omega$	25°C	±10	±13		±10	±13		l
		$R_L \ge 2 k\Omega$	Full range	±10			±10			
۸	Large-signal differential	$R_L \ge 2 k\Omega$	25°C	20	200		50	200		V/mV
AVD	voltage amplification	V _O = ±10 V	Full range	15			25			V/IIIV
rį	Input resistance		25°C	0.3	2		0.3	2		MΩ
r _O	Output resistance	$V_O = 0$, See Note 5	25°C		75			75		Ω
Ci	Input capacitance		25°C		1.4			1.4		pF
CMRR	Common-mode rejection	V _{IC} = V _{ICR} min	25°C	70	90		70	90		dB
CIVIKK	ratio	AIC = AICKIIIII	Full range	70			70			uБ
kayra	Supply voltage sensitivity	V _{CC} = ±9 V to ±15 V	25°C		30	150		30	150	μV/V
ksvs	$(\Delta V_{IO}/\Delta V_{CC})$	ACC = ±8 A 10 ± 12 A	Full range			150			150	μν/ν
los	Short-circuit output current		25°C		±25	±40		±25	±40	mA
loo	Supply current	$V_O = 0$, No load	25°C		1.7	2.8		1.7	2.8	mA
Icc	очрріу сипепі	VO = 0, INO IOAU	Full range			3.3			3.3	ША
PD	Total power dissipation	$V_{\Omega} = 0$, No load	25°C		50	85		50	85	mW
ט ין	Total power dissipation	VO = 0, No load	Full range			100			100	11100

[†] All characteristics are measured under open-loop conditions with zero common-mode input voltage unless otherwise specified. Full range for the μ A741C is 0°C to 70°C, the μ A741I is -40°C to 85°C, and the μ A741M is -55°C to 125°C.

operating characteristics, $V_{CC\pm}$ = ±15 V, T_A = 25°C

PARAMETER		TEST CONDITIONS -		μ Α741C			μ Α741Ι, μ Α741Μ			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	UNII
t _r	Rise time	$V_{I} = 20 \text{ mV},$	$R_L = 2 k\Omega$,		0.3			0.3		μs
	Overshoot factor	$C_L = 100 pF$,	See Figure 1		5%			5%		
SR	Slew rate at unity gain	V _I = 10 V, C _L = 100 pF,	$R_L = 2 k\Omega$, See Figure 1		0.5			0.5		V/μs



NOTE 5: This typical value applies only at frequencies above a few hundred hertz because of the effects of drift and thermal feedback.

electrical characteristics at specified free-air temperature, $V_{CC\pm}$ = ± 15 V, T_A = $25^{\circ}C$ (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	μ	A741Y		UNIT	
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNII	
VIO	Input offset voltage	V _O = 0		1	6	mV	
$\Delta V_{IO(adj)}$	Offset voltage adjust range	V _O = 0		±15		mV	
IIO	Input offset current	V _O = 0		20	200	nA	
I _{IB}	Input bias current	V _O = 0		80	500	nA	
VICR	Common-mode input voltage range		±12	±13		V	
\/014	Maximum neak autaut valtaga aving	$R_L = 10 \text{ k}\Omega$	±12	±14		V	
VOM	Maximum peak output voltage swing	$R_L = 2 k\Omega$	±10	±13			
A _{VD}	Large-signal differential voltage amplification	$R_L \ge 2 k\Omega$	20	200		V/mV	
rį	Input resistance		0.3	2		ΜΩ	
r _O	Output resistance	$V_O = 0$, See Note 5		75		Ω	
Ci	Input capacitance			1.4		pF	
CMRR	Common-mode rejection ratio	V _{IC} = V _{ICR} min	70	90		dB	
ksvs	Supply voltage sensitivity ($\Delta V_{IO}/\Delta V_{CC}$)	$V_{CC} = \pm 9 \text{ V to } \pm 15 \text{ V}$		30	150	μV/V	
los	Short-circuit output current			±25	±40	mA	
Icc	Supply current	V _O = 0, No load		1.7	2.8	mA	
P_{D}	Total power dissipation	$V_O = 0$, No load		50	85	mW	

[†] All characteristics are measured under open-loop conditions with zero common-mode voltage unless otherwise specified.

NOTE 5: This typical value applies only at frequencies above a few hundred hertz because of the effects of drift and thermal feedback.

operating characteristics, $V_{CC}\pm$ = ±15 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	μ Α741Υ			UNIT
	FARAINETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _r	Rise time	$V_{\parallel} = 20 \text{ mV}, R_{\perp} = 2 \text{ k}\Omega,$		0.3		μs
	Overshoot factor	C _L = 100 pF, See Figure 1		5%		
SR	Slew rate at unity gain	$V_{\parallel} = 10 \text{ V}, \qquad R_{\perp} = 2 \text{ k}\Omega,$ $C_{\perp} = 100 \text{ pF}, \qquad \text{See Figure 1}$		0.5	·	V/μs



PARAMETER MEASUREMENT INFORMATION

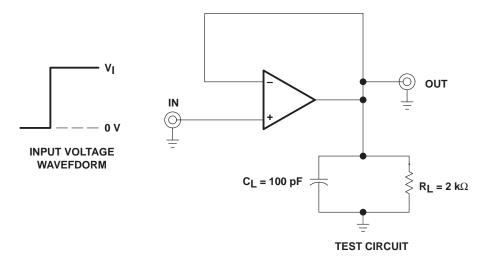


Figure 1. Rise Time, Overshoot, and Slew Rate

APPLICATION INFORMATION

Figure 2 shows a diagram for an input offset voltage null circuit.

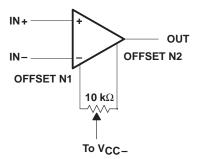
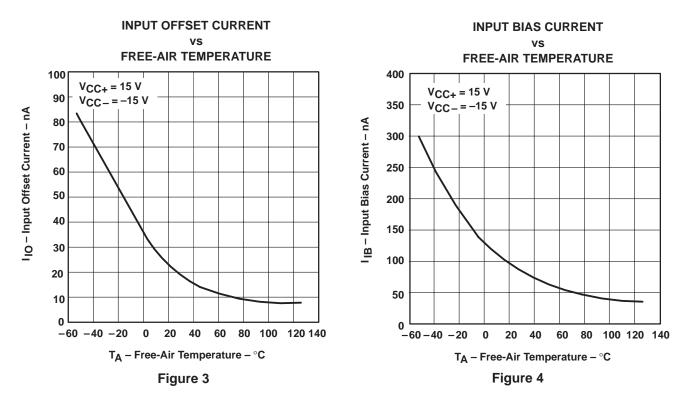
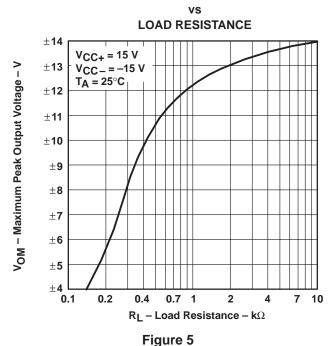


Figure 2. Input Offset Voltage Null Circuit

TYPICAL CHARACTERISTICS[†]



MAXIMUM PEAK OUTPUT VOLTAGE



[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



TYPICAL CHARACTERISTICS

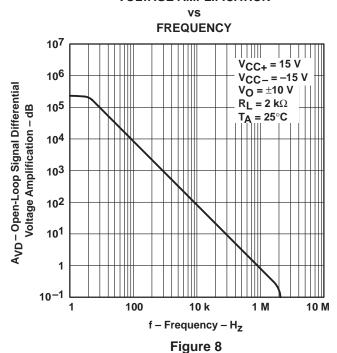
MAXIMUM PEAK OUTPUT VOLTAGE FREQUENCY ± 20 V_{CC+} = 15 V V_{OM} – Maximum Peak Output Voltage – V ± 18 $V_{CC} = -15 \text{ V}$ $R_L = 10 \text{ k}\Omega$ ±16 T_A = 25°C ±14 ±12 ±10 ±8 ± 6 ± 4 $\pm \mathbf{2}$ 0 1 k 10 k 100 k 1 M f - Frequency - Hz

Figure 6

OPEN-LOOP SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION vs **SUPPLY VOLTAGE** 400 V_O = ±10 V $R_L = 2 k\Omega$ T_A = 25°C A_{VD}- Open-Loop Signal Differential 200 Voltage Amplification - V/mV 100 40 20 10 2 0 4 6 8 10 12 14 16 18 20 V_{CC±} - Supply Voltage - V

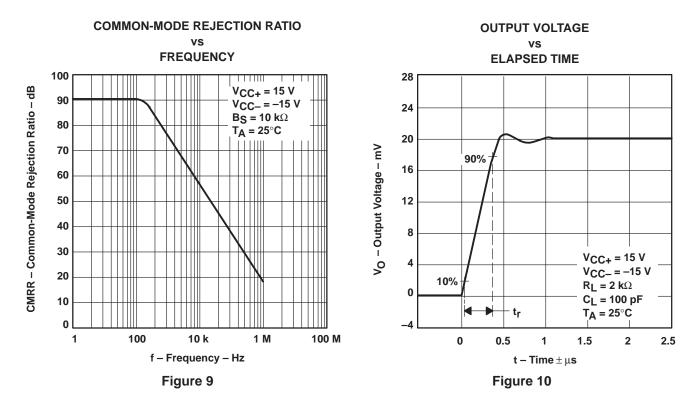
Figure 7

OPEN-LOOP LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION





TYPICAL CHARACTERISTICS



VOLTAGE-FOLLOWER LARGE-SIGNAL PULSE RESPONSE

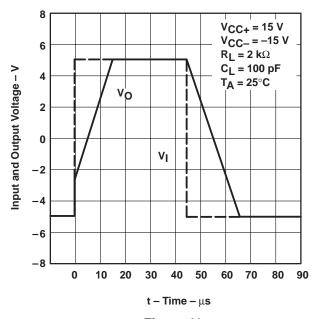


Figure 11

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